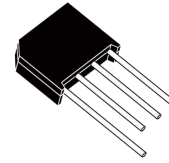


VOLTAGE RANGE: 50 - 1000V
CURRENT: 4.0 A

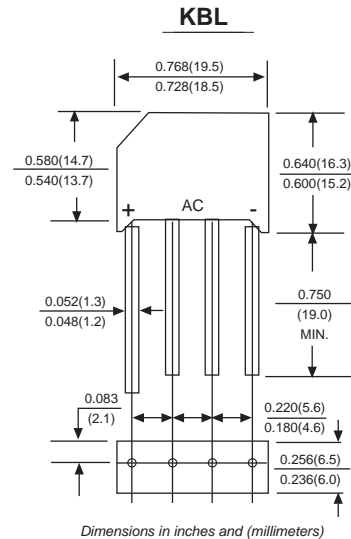


Features

- Diffused Junction
- Low Forward Voltage Drop
- High Current Capability
- High Reliability
- High Surge Current Capability
- Ideal for Printed Circuit Boards

Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: As Marked on Body
- Weight: 5.6 grams (approx.)
- Mounting Position: Any
- Marking: Type Number



Maximum Ratings and Electrical Characteristics T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	KBL 400	KBL 401	KBL 402	KBL 404	KBL 406	KBL 408	KBL 410	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Working Peak Reverse Voltage	V _{RWM}								
DC Blocking Voltage	V _R								
RMS Reverse Voltage	V _{R(RMS)}	35	70	140	280	420	560	700	V
Average Rectified Output Current @T _C = 75°C	I _O	4.0							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	150							A
Forward Voltage (per element) @I _F = 2.0A	V _{FM}	1.1							V
Peak Reverse Current @T _C = 25°C	I _R	10							μA
At Rated DC Blocking Voltage @T _C = 100°C		1.0							mA
Rating for Fusing (t < 8.3ms) (Note 1)	I _t ²	166							A ² s
Typical Thermal Resistance (Note 2)	R _{θJC}	19							K/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +125							°C

Note: 1. Non-repetitive for t > 1ms and < 8.3ms.

2. Thermal resistance junction to case per element mounted on PC board with 13.0x13.0x0.03mm thick land areas.

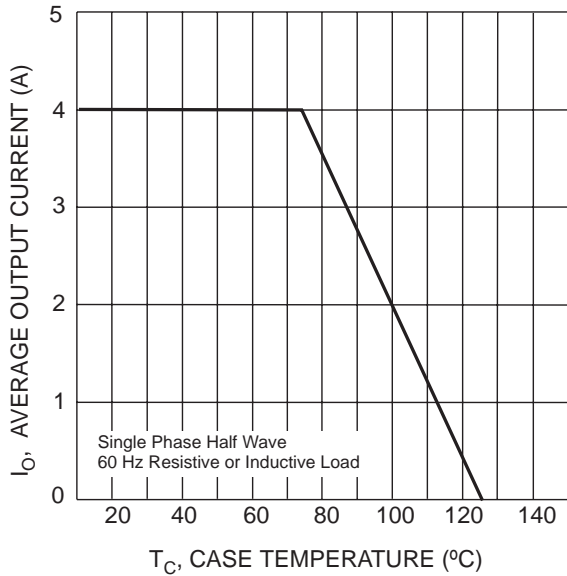


Fig. 1 Forward Current Derating Curve

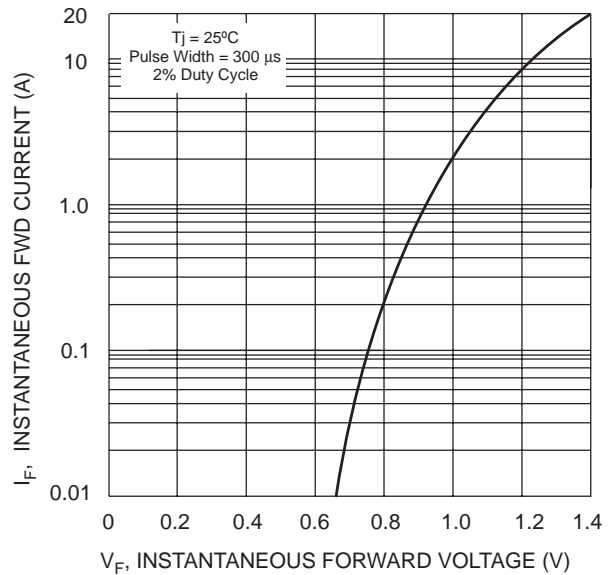


Fig. 2 Typical Forward Characteristics, per element

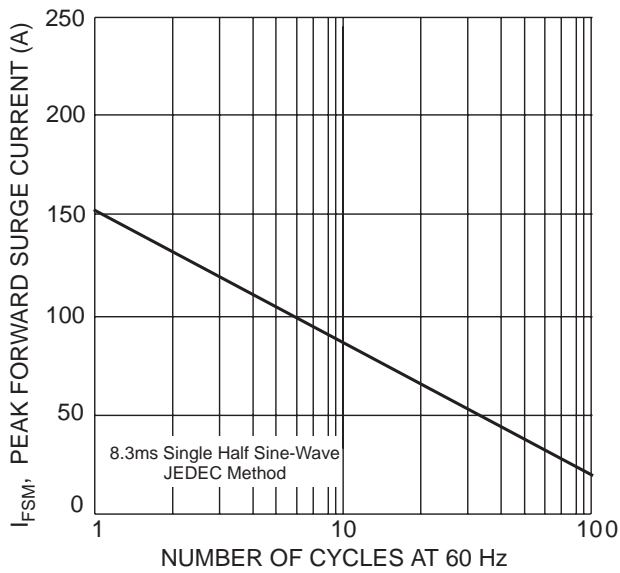


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

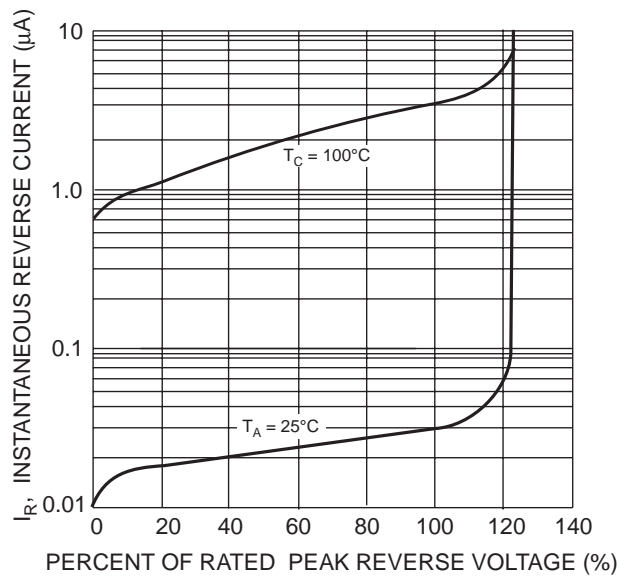


Fig. 4 Typical Reverse Characteristics, per element